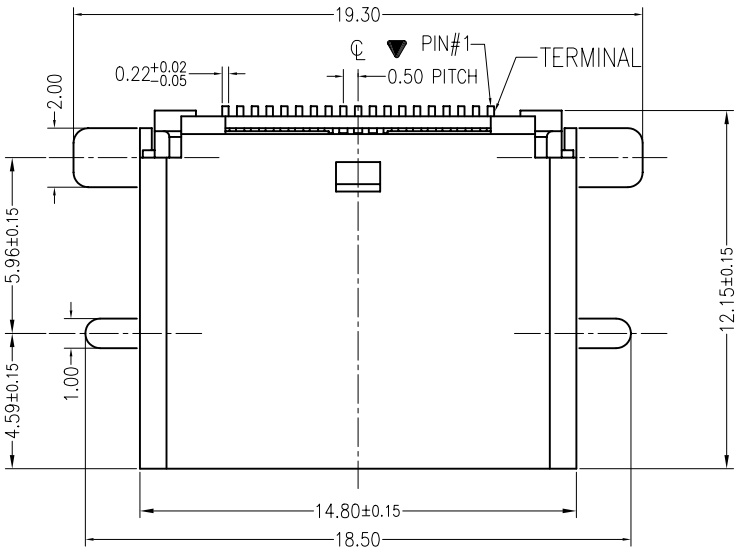
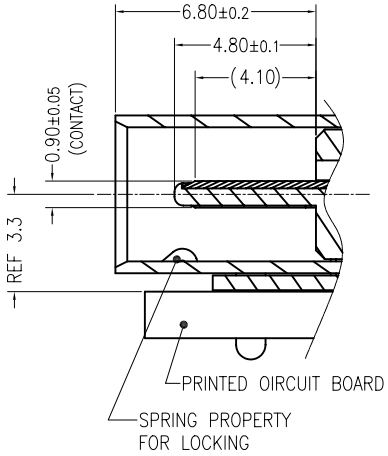
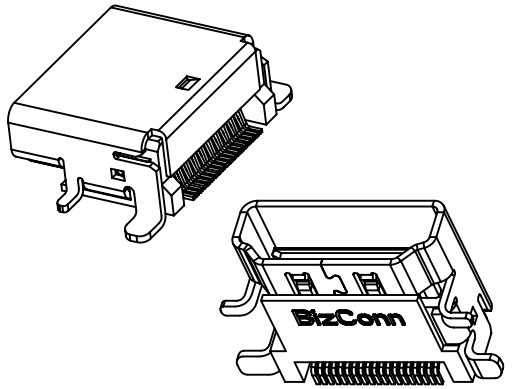
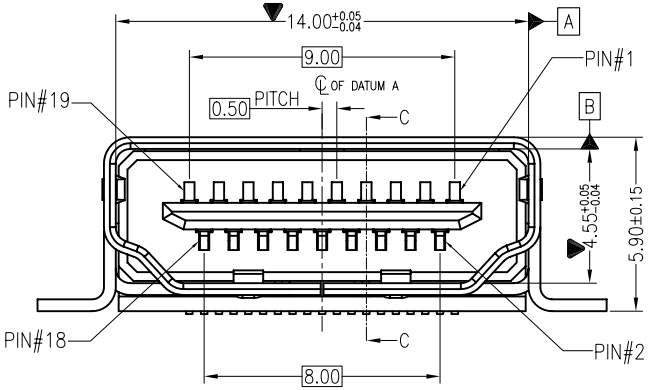
REV.	DATE	CONTENT	ECN. NO.
X0	2005.01.21	ISSUE	

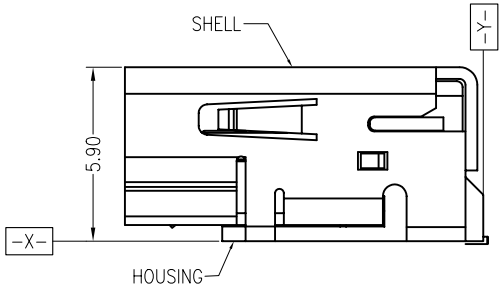


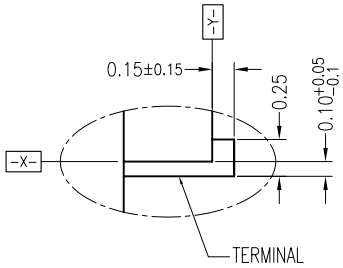


SECTION C-C

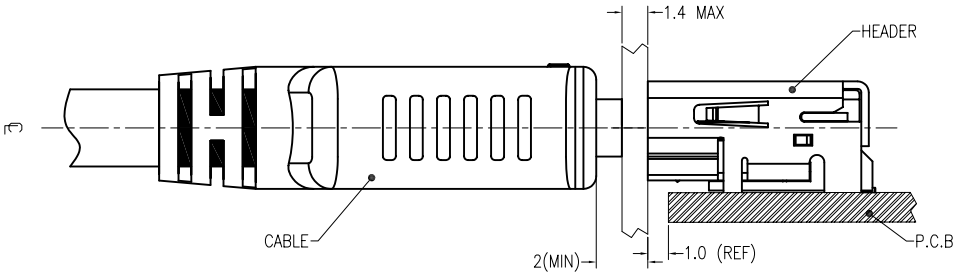








DETAIL A(5:1)

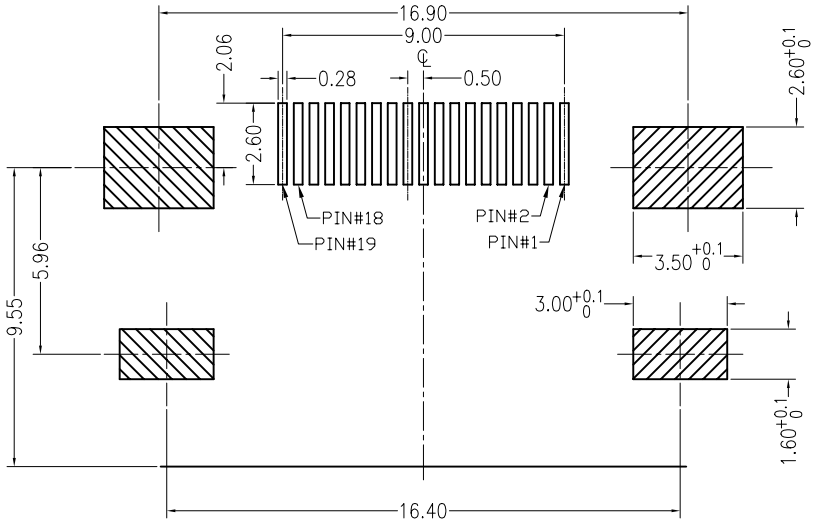


REFERENCE MOUNT DIMENSION.

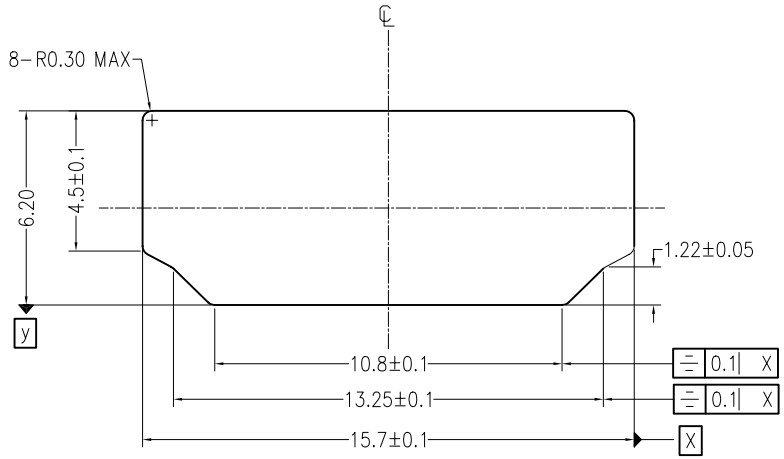
(SCALE 2-1)

X. ±0.5	X° ±1°	UNITS: MM	NAME(INTENDED USE) SALES FOR HDMI-19PIN HEADER(SMT)	BizConn BizConn International Electronic CO.,LTD.	
.X ±0.38	.X° ±0.5°	MAT'L: SEE NOTE	PART NO.(INTENDED USE) 662-19LNBSANBNA	FILE NO.: WDR-032-05***	
.XX ±0.20	.XX°±	FINISH SEE NOTE	APPD:	PROJECT NO. BC-M05***	
.XXX± 0.10	.XXX°±	Q'TY	CHKD:	SCALE: NONE	SHEET: 1/2
QUALITY SYMBOLS CRITICAL=▽ MAJOR=▼			DR: 程襄東 2005.01.21		REV.: X0

REV.	DATE	CONTENT	ECN. NO.
X0	2005.01.21	ISSUE	



RECOMMENDED P.C.B. PATTERN LAYOUT(T=1.6±0.1)



▽1 REFERENCPANLE CUT OUTE MOUNT DIMENSION.

NOTE:

1. MATERIAL
   HOUSING: GLASS FILLED HEAT-RESISTED RESIN. UL94V-0
   TERMINAL: COPPER ALLOY
   SHELL COPPER ALLOY
2. PLATING
   TERMINAL : (CONTACT AREA) GOLD(Au)
   (SOLDERTAIL AREA) TIN-COPPER
   (UNDER-PLATING) NICKEL(Ni)
   SHELL : TIN-COPPER
   UNDER-PLATING NICKEL (Ni)
3. PRODUCT CODE

662 - 19 * * * ** * * * *

- T--SMT(鐵殼R/A); D--R/A DIP V--180°SMT ; A--SMT(鐵殼SMT)
- MARK: N-NO MARK ; B-BIZCONN
- COLOR: B-Black ; W-White
- A:有接地片(M3*0.5) B:有接地片(4-40 UNC) N:無接地片
- PLATING:
  SA--15u"Au, 50u"Ni,100u"Sn;
  SD--5u"Au,50u"Ni,100u"Sn;
  SE--10u"Au,50u"Ni,100u"Sn;
  SF--30u"Au,50u"Ni,100u"Sn;
- Terminal Material:
  P--PHOSPHOR BRONZE
  B--BRONZE
- SHELL PLATING:
  N--PLATING Ni
  T--PLATING Sn
  Z--PLATING Zn
  G--GOLD FLASH
- HOUSING:
  P:PBT L:LCP N:NYLON
- 19--19PIN ; 29--29PIN
- 662--HDMI HEADER

X. ±0.5	X° ±1°	UNITS: MM	NAME(INTENDED USE) SALES FOR HDMI-19PIN HEADER(SMT)
.X ±0.38	.X° ±0.5°	MAT'L: SEE NOTE	PART NO.(INTENDED USE) 662-19LNBSANBNA
.XX ±0.20	.XX°±		APPD:
.XXX± 0.10	.XXX°±	FINISH SEE NOTE	CHKD:
QUALITY SYMBOLS CRITICAL=▽ MAJOR=▼		Q'TY	DR: 程襄東 2005.01.21

BizConn
BizConn International Electronic CO.,LTD.

FILE NO.: WDR-032-05***

PROJECT NO. BC-M05***

SCALE	SHEET	REV.
NONE	2/2	X0